Hunteck

30V P-Ch Power MOSFET

V_{DS}		-30	V
$R_{DS(on),typ}$	$V_{GS}=10V$	75	mΩ
$R_{DS(on),typ}$	$V_{GS}=4.5V$	125	mΩ
$I_{D\ (Sillicon\ Limited)}$		-3.6	A

Feature
º High Speed Power Switching, Logic Level
º Enhanced Avalanche Ruggedness
º Lead Free, Halogen Free

Application
º Load Switches
º Hard Switching and High Speed Circuit
º BLDC Motor
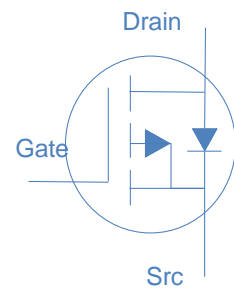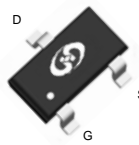
SOT-23

Part Number	Package	Marking
HTJ850P03	SOT-23	24

Absolute Maximum Ratings at T_j=25 (unless otherwise specified)

Parameter	Symbol	Conditions	Value	Unit
Continuous Drain Current (Silicon Limited)	I_D	T_A=25	-3.6	A
		T_A=70	-2.5	
Drain to Source Voltage	V_{DS}	-	-30	V
Gate to Source Voltage	V_{GS}	-	±20	V
Pulsed Drain Current	I_{DM}	-	-14	A
Power Dissipation	P_D	T_A=25	1.04	W
Operating and Storage Temperature	T_J, T_{stg}	-	-55 to150	

Absolute Maximum Ratings

Parameter	Symbol	Max	Unit
Thermal Resistance Junction-Ambient	$R_{\theta JA}$	120	/W

Electrical Characteristics at T_j=25   (unless otherwise specified)

Static Characteristics

Parameter	Symbol	Conditions	Value			Unit
			min	typ	max	
Drain to Source Breakdown Voltage	$V_{(BR)DSS}$	V_{GS}=0V, I_D=-250μA	-30	-	-	V
Gate Threshold Voltage	$V_{GS(th)}$	V_{GS}=V_{DS}, I_D=-250μA	-1	-1.5	-3	
Zero Gate Voltage Drain Current	I_{DSS}	V_{GS}=0V, V_{DS}=-24V, T_j=25	-	-	-1	μA
		V_{GS}=0V, V_{DS}=-20V, T_j=125	-	-	-10	
Gate to Source Leakage Current	I_{GSS}	V_{GS}=±20V, V_{DS}=0V	-	-	±100	nA
Drain to Source on Resistance	$R_{DS(on)}$	V_{GS}=-10V, I_D=-3.6A	-	75	85	mΩ
		V_{GS}=-4.5V, I_D=-2.5A	-	125	145	
Transconductance	g_{fs}	V_{DS}=-5V, I_D=-3A	-	5	-	S

Dynamic Characteristics

Parameter	Symbol	Conditions	Value			Unit
Input Capacitance	C_{iss}	V_{GS}=0V, V_{DS}=-15V, f=1MHz	-	337	-	pF
Output Capacitance	C_{oss}		-	48	-	
Reverse Transfer Capacitance	C_{rss}		-	36	-	
Total Gate Charge	Q_g	V_{DD}=-10V, I_D=-3A, V_{GS}=-10V	-	5.1	-	nC
Gate to Source Charge	Q_{gs}		-	0.9	-	
Gate to Drain (Miller) Charge	Q_{gd}		-	1.1	-	
Turn on Delay Time	$t_{d(on)}$	V_{DD}=-10V, I_D=-1A, V_{GS}=-10V, R_G=6Ω,	-	15	-	ns
Rise time	t_r		-	30	-	
Turn off Delay Time	$t_{d(off)}$		-	35	-	
Fall Time	t_f		-	30	-	

Reverse Diode Characteristics

Parameter	Symbol	Conditions	Value			Unit
Diode Forward Voltage	V_{SD}	V_{GS}=0V, I_F=-2A	-		-1.2	V

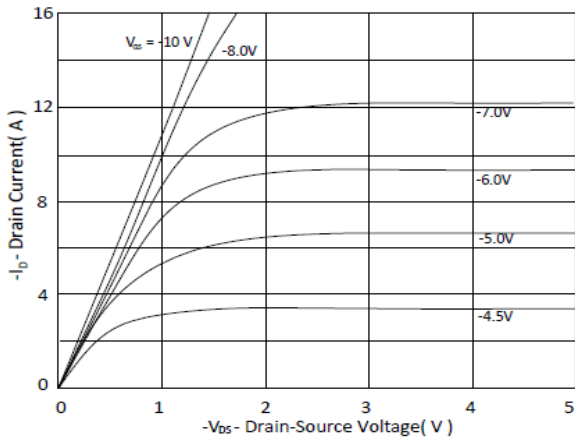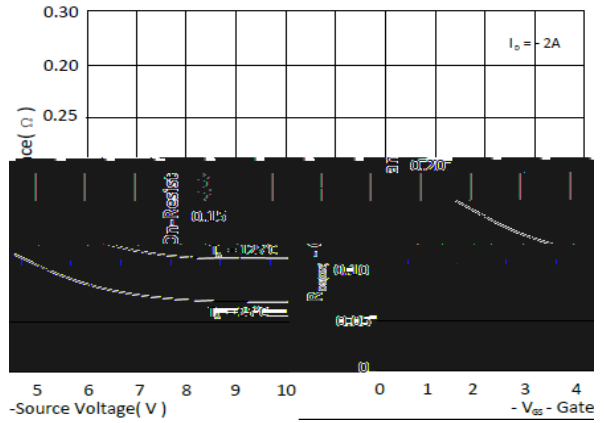| Fig 1. Typical Output Characteristics	Figure 2. On-Resistance vs. Gate-Source Voltage

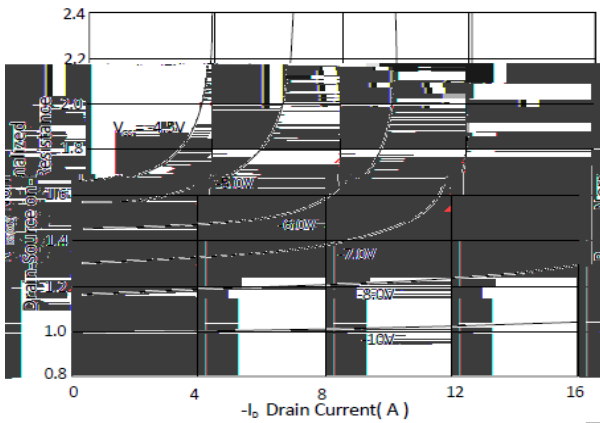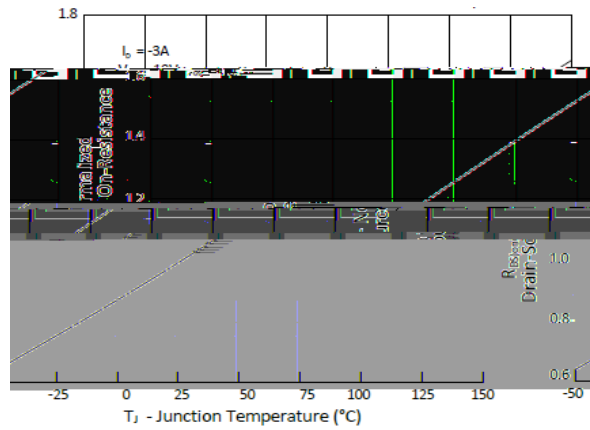| Figure 3. On-Resistance vs. Drain Current and Gate Voltage	Figure 4. Normalized On-Resistance vs. Junction Temperature

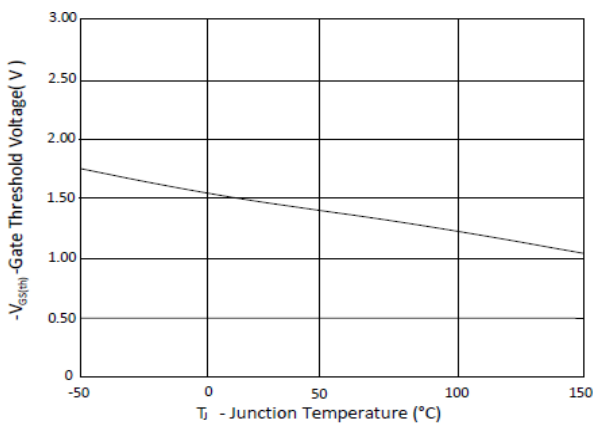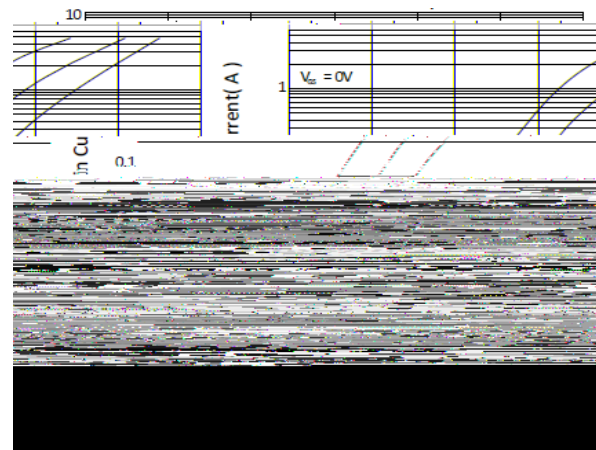| Figure 5. Gate Threshold Voltage v.s. Junction Temperature	Figure 6. Typical Source-Drain Diode Forward Voltage

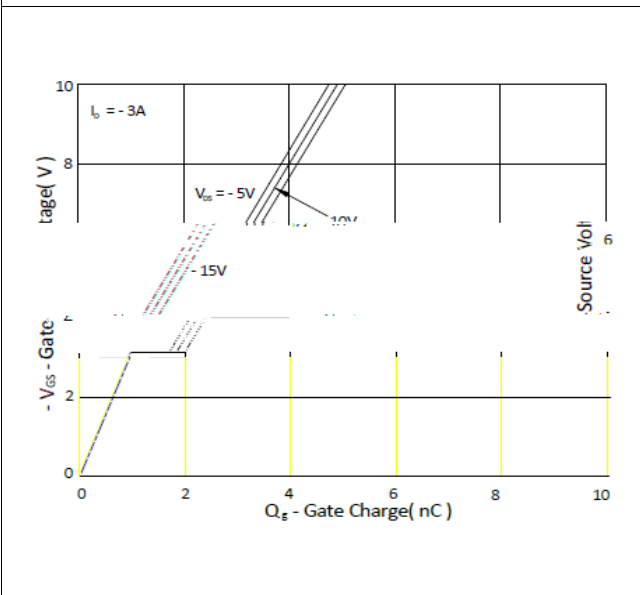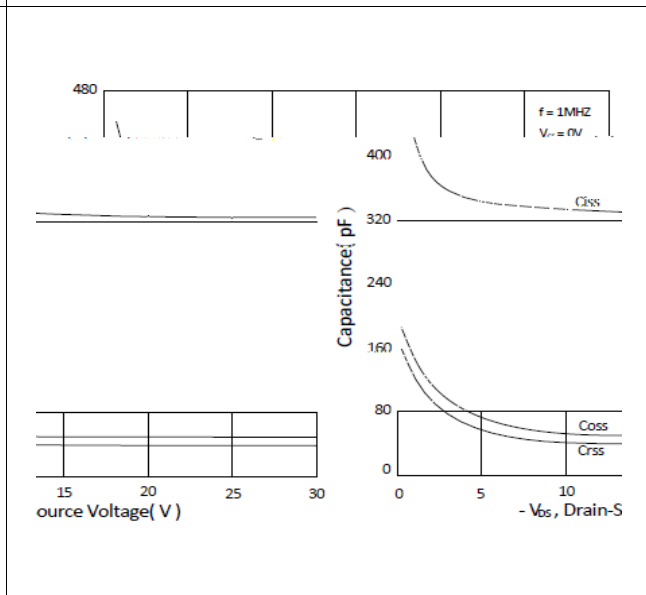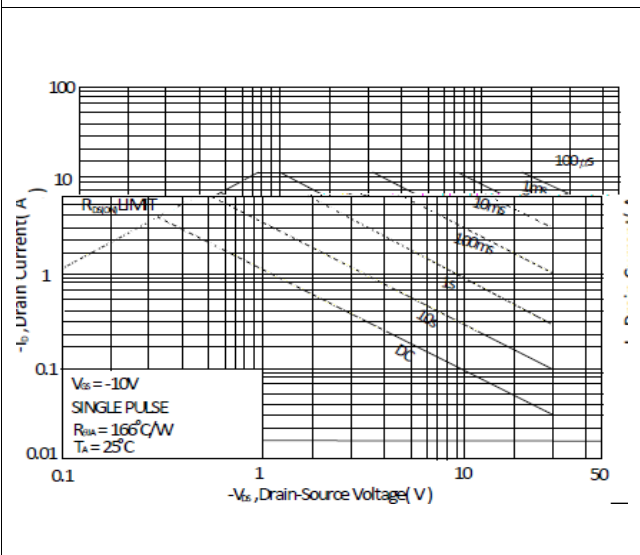| Figure 7. Typical Gate-Charge vs. Gate-to-Source Voltage	Figure 8. Typical Capacitance vs. Drain-to-Source Voltage

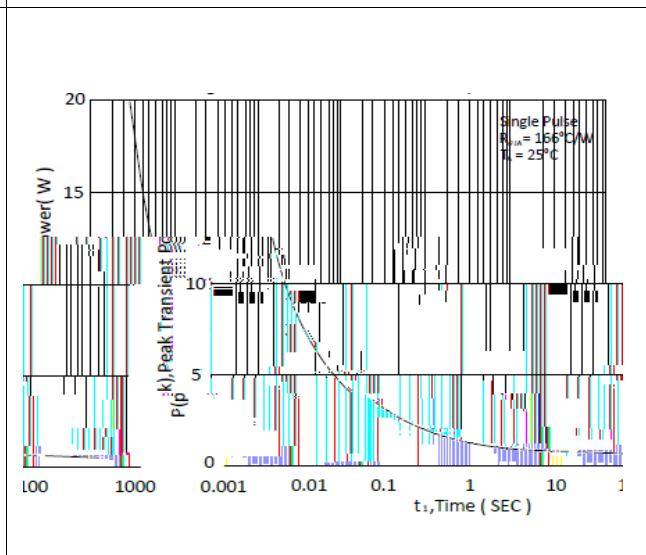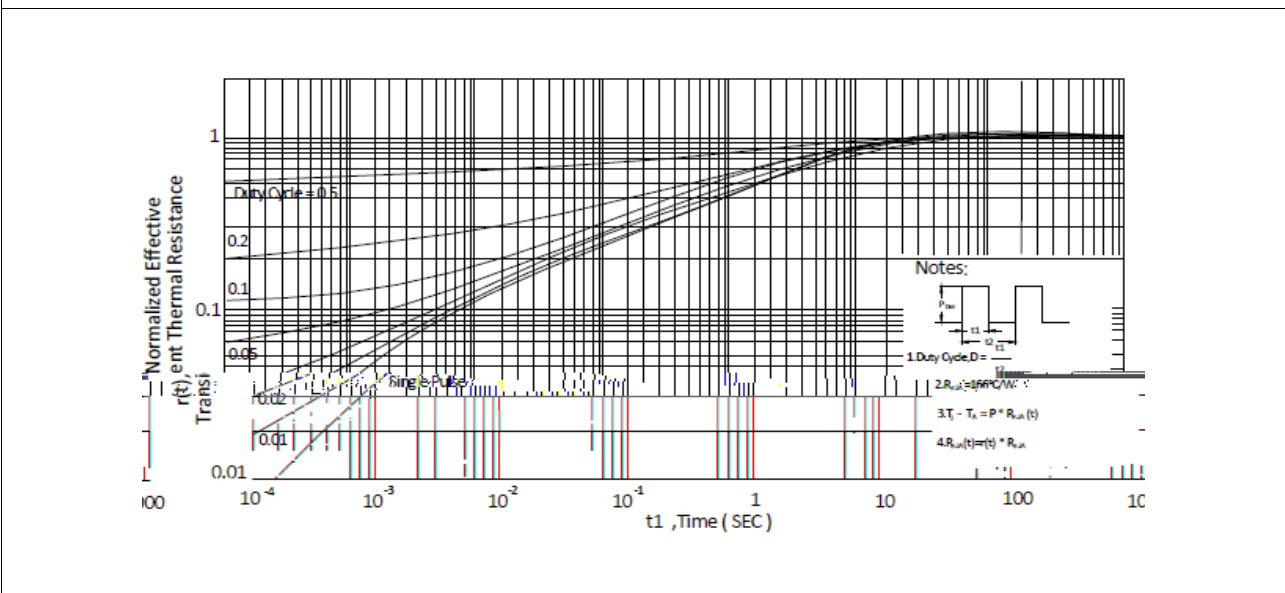| Figure 9. Maximum Safe Operating Area	Figure 10. Maximun Drain Current vs. Case Temperature

Figure 11. Normalized Maximum Transient Thermal Impedance, Junction-to-Ambient

Inductive switching Test

Gate Charge Test

Uclamped Inductive Switching (UIS) Test

Diode Recovery Test

Package Outline